

Multi-Cure® 984-LVUF Ultra-Fluorescing Conformal Coating

APPLICATIONS

· Conformal Coating

FEATURES

- UV/Visible Light Cure
- · Secondary Heat Cure
- Solvent-Free and Halogen Free
- One Part, No Mixing or Dilution Required
- Flexible for Enhanced Thermal Shock Performance

OTHER FEATURES

- MIL-I-46058C Listed
- IPC-CC-830-B Approved
- UL 746C Qualified
- UL 94 V0 Recognized

Dymax Multi-Cure® 984-LVUF is a highly fluorescing, single-component, 100%-solids conformal coating specifically formulated for rapid room-temperature curing when exposed to UV light. 984-LVUF retains high fluorescence after curing. Thin-layer coatings cure almost instantly to a depth of 7 mils and fluoresce upon exposure to "black" light. Multi-Cure 984-LVUF also exhibits adhesion to a variety of metal, ceramic, and glass-filled epoxy surfaces. 984-LVUF is a moderately low-viscosity coating which can be cured by exposure to UV light and secondarily cured with heat for shadow areas on densely populated circuit boards. Dymax Multi-Cure materials contain no nonreactive solvents and cure upon exposure to light. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing spot lamps, focused-beam lamps, or flood lamps, they deliver optimum speed and performance for conformal coating. Dymax lamps offer the ideal balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

UNCURED PROPERTIES *		
Property	Value	Test Method
Solvent Content	No Nonreactive Solvents	N/A
Chemical Class	Acrylated Urethane	N/A
Appearance	Colorless Transparent Liquid	N/A
Soluble in	Organic Solvents	N/A
Density, g/ml	1.05	ASTM D1875
Viscosity, cP (20 rpm)	160	ASTM D1084
Shelf Life at Recommended Conditions from Date of Manufacture	18 months	N/A

CURED MECHANICAL PROPERTIES *		
Property	Value	Test Method
Durometer Hardness	D85	ASTM D2240
Tensile at Break, MPa [psi]	55.8 [8,100]	ASTM D638
Elongation at Break, %	4	ASTM D638
Modulus of Elasticity, MPa [psi]	724 [105,100]	ASTM D638
Glass Transition Tg, °C	84	DSTM 256‡
CTEα _{1,} μm/m/°C	70	ASTM E831
${\sf CTE}\alpha_{2,}\ \mu{\sf m/m/^{\circ}C}$	227	ASTM E831

OTHER CURED PROPERTIES *		
Property	Value	Test Method
Refractive Index (20° C)	1.49	ASTM D542
Boiling Water Absorption, % (2 hr)	1.3	ASTM D570
Water Absorption, % (25°C, 24 hr)	0.2	ASTM D570
Linear Shrinkage, %	0.1	DSTM 614‡
Thermal Shock, -65°C to 125°C	50 cycles	MIL-I-46058C
Flammability	V0	UL 94
Dielectric Withstand Voltage	>1500 volts	MIL-I-46058C
Moisture Resistance	Passes	MIL-I-46058C
Fungus Resistance (ASTM G21-13)	Passes	MIL-I-46058C

ELECTRICAL PROPERTIES *		
Property	Value	Test Method
Dielectric Constant (1 MHz)	3.4	ASTM D1304
Dissipation Factor (1 MHz)	0.03	ASTM D1304
Dielectric Withstand Voltage, V	1800	ASTM D1304
Volume Resistivity, ohm-cm	35.8E+12	ASTM D1304
Surface Resistivity, ohms	384E+12	ASTM D1304



[‡] DSTM Refers to Dymax Standard Test Method





 $^{\ \, \}text{@}$ 2023 Dymax Corporation.All rights reserved.



ELECTRONIC CIRCUIT BOARD MATERIALS 984-LVUF Product Data Sheet

ADHESION	
Substrate	Recommendation
Lead Frame	>
Ceramic	~
PCB	~
Flex	*
Silicon	~

[✓] Recommended

CURING GUIDELINES

UV-curing guidelines for 984-LVUF at 0.005" (127 µm)

Dymax Curing System (Intensity)	Fixture Time or Belt Speed
5000-EC (225 mW/cm ²) ^A	40 s
UVCS Conveyor with Fusion D lamp (2.5 W/cm²) ^B	1.5 m/min [5 ft/min]

- A Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.

 B Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 160 Radiometer.

Full cure is best determined empirically by curing at different times and intensities, and measuring the corresponding change in cured properties such as tackiness, adhesion, hardness, etc. Full cure is defined as the point at which more light exposure no longer improves cured properties. Higher intensities or longer cures (up to 5x) generally will not degrade Dymax light-curable adhesives.

Dymax recommends that customers employ a safety factor by curing longer and/or at higher intensities than required for full cure. Although Dymax Application Engineering can provide technical support and assist with process development, each customer ultimately must determine and qualify the appropriate curing parameters required for their unique application.

SECONDARY HEAT CURE

Heat can be used as a secondary cure mechanism where the adhesive cannot be cured with light. Light curing must be done prior to heat cure. The following heatcure schedule may be used:

Temperature	Time*
110°C [230°F]	60 minutes
120°C [250°F]	30 minutes
150°C [300°F]	15 minutes

^{*}Note: Actual heat-cure time may vary due to part configuration, volume of adhesive applied, and oven efficiency.

o Limited Applications

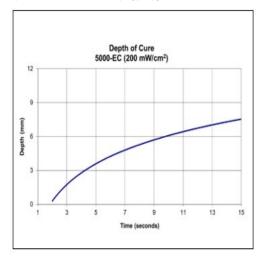
st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)

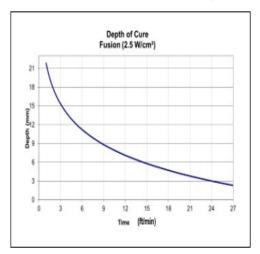


ELECTRONIC CIRCUIT BOARD MATERIALS 984-LVUF Product Data Sheet

DEPTH OF CURE

The graphs below show the increase in depth of cure as a function of exposure time with two different lamps at different intensities. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured.





OPTIMIZING PERFORMANCE AND HANDLING

- 1. This product cures with exposure to UV and visible light. Exposure to ambient and artificial light should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
- 2. All surfaces in contact with the material should be clean and free from flux residue, grease, mold release, or other contaminants prior to dispensing the material.
- 3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, thickness, and percent light transmission of components between the material and light source.
- 4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity (>100 mW/cm²) UV light to produce a dry surface cure. Flooding the curing area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.
- 5. Parts should be allowed to cool after cure before testing and subjecting to any loads or electrical testing.
- 6. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
- 7. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.

DISPENSING SUPPORT

The Dymax Application Engineering team is ready to discuss your application requirements to provide the most appropriate dispensing and/or spraying solution. Visit our current dispensing equipment portfolio here or consult our global contact phone numbers and online chat feature (available in North America only) during normal business hours for instant support.

STORAGE AND SHELF LIFE

Store the material in a cool, dark place when not in use. Do not expose to light. This product may polymerize upon prolonged exposure to ambient and artificial light. Keep covered when not in use. This material shelf life noted on page 1 of this document, when stored between 10°C (50°F) and 32°C (90°F) in the original, unopened container.

CLEAN UP

Uncured material may be removed from dispensing components and parts with organic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods such as ultrasonic bath, water jet, vacuum tweezers, air knife and/or warming to aid in the removal.



ELECTRONIC CIRCUIT BOARD MATERIALS 984-LVUF Product Data Sheet

GENERAL INFORMATION

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

The data provided in this document are based on historical testing that Dymax performed under laboratory conditions as they existed at that time and are for informational purposes only. The data are neither specifications nor guarantees of future performance in a particular application. Dymax does not guarantee that this product's properties are suitable for the user's intended purpose.

Numerous factors—including, without limitation, transport, storage, processing, the material with which the product is used, and the ultimate function or purpose for which the product was obtained—may affect the product's performance and/or may cause the product's actual behavior to deviate from its behavior in the laboratory. None of these factors are within Dymax's control. Conclusions about the behavior of the product under the user's particular conditions, and the product's suitability for a specific purpose, cannot be drawn from the information contained in this document.

It is the user's responsibility to determine (i) whether a product is suitable for the user's particular purpose or application and (ii) whether it is compatible with the user's intended manufacturing process, equipment, and methods. Under no circumstances will Dymax be liable for determining such suitability or compatibility. Before the user sells any item that incorporates Dymax's product, the user shall adequately and repetitively test the item in accordance with the user's procedures and protocols. Unless specifically agreed to in writing, Dymax will have no involvement in, and shall under no circumstances be liable for, such testing.

Dymax makes no warranties, whether express or implied, concerning the merchantability of this product or its fitness for a particular purpose. Nothing in this document should be interpreted as a warranty of any kind. Under no circumstances will Dymax be liable for any injury, loss, expense or incidental or consequential damage of any kind allegedly arising in connection with the user's handling, processing, or use of the product. It is the user's responsibility to adopt appropriate precautions and safeguards to protect persons and property from any risk arising from such handling, processing, or use.

The specific conditions of sale for this product are set forth in Dymax's <u>General Terms & Conditions of Sale</u>. Nothing contained herein shall act as a representation that the product use or application is free from patents owned by Dymax or any others. Nothing contained herein shall act as a grant of license under any Dymax Corporation Patent.

Except as otherwise noted, all trademarks used herein are trademarks of Dymax. The "®" symbol denotes a trademark that is registered in the U.S. Patent and Trademark Office.

The contents of this document are subject to change. Unless specifically agreed to in writing, Dymax shall have no obligation to notify the user about any change to its content.

CONTACT DYMAX

www.dymax.com

Americas

USA | +1.860.482.1010 | info@dymax.com

Europe

Germany | +49 611.962.7900 | info_de@dymax.com | reland | +353 21.237.3016 | info_ie@dymax.com

Asia

Singapore | +65.67522887 | info_ap@dymax.com Shenzhen | +86.755.83485759 | dymaxasia@dymax.com Hong Kong | +852.2460.7038 | dymaxasia@dymax.com Korea | +82.31.608.3434 | info_kr@dymax.com